



SBR2A40P1

2.0A SBR®

SURFACE MOUNT SUPER BARRIER RECTIFIER

Features

- Low Forward Voltage Drop
- Low Leakage Current
- Superior Reverse Avalanche Capability
- **Excellent High Temperature Stability**
- Patented Interlocking Clip Design for High Surge Current
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- ±16KV ESD Protection (HBM, 3B)
- ±25KV ESD Protection (IEC61000-4-2 Level 4, Air Discharge)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q 101 Standards for High Reliability
- PPAP Capable (See Note 4)

Mechanical Data

- Case: PowerDI®123
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (93)
- Weight: 0.018 grams (Approximate)

PowerDI®123



Top View

Ordering Information (Notes 5 & 6)

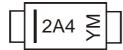
Part Number	Compliance	Case	Packaging
SBR2A40P1-7	AEC-Q101	PowerDI [®] 123	3,000/Tape & Reel
SBR2A40P1Q-7	Automotive	PowerDI®123	3,000/Tape & Reel

Notes:

- EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/. 5. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 6. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

PowerDI®123



2A4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015)M = Month (ex: 9 = September)

Date Code Kev

Code

Year	2006	2015	2016	2017	2018	2019	2020	2021	2022	2023
Code	Т	С	D	Е	F	G	Н	I	J	K
Month	Jan	Feb	Mar Ar	or Mav	Jun	Jul	Aua	Sep Od	et Nov	Dec



Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	40	V
DC Blocking Voltage	V_{RM}		
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current (See Figure 1)	Ιο	2.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms	I _{FSM}	50	Α
Single Half Sine-Wave Superimposed on Rated Load			
Repetitive Peak Avalanche Power (1µs, +25°C)	PARM	6,000	W

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 7) Thermal Resistance Junction to Ambient (Note 8) Thermal Resistance Junction to Ambient (Note 9)	R _e Js R _e Ja R _e JA	5 180 115	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

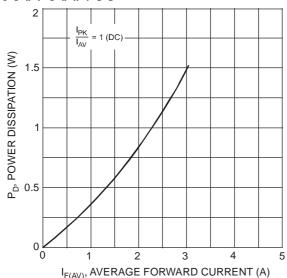
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	$V_{(BR)R}$	40	-	-	V	$I_R = 100\mu A$
	V _F	-	0.265	0.315	V	$I_F = 0.1A, T_J = +25$ °C
		-	0.38	0.43		I _F = 1.0A, T _J = +25°C
Forward Voltage Drop		-	0.45	0.50		I _F = 2.0A, T _J = +25°C
Forward Voltage Drop		-	0.17	0.22		$I_F = 0.1A, T_J = +125$ °C
		-	0.325	0.375		$I_F = 1.0A, T_J = +125$ °C
		-	0.42	0.47		$I_F = 2.0A, T_J = +125$ °C
Leakage Current (Note 5)	I _R	-	8	40	μA	$V_R = 5V, T_J = +25^{\circ}C$
		-	16	100	μΑ	$V_R = 40V, T_J = +25^{\circ}C$
		-	1.3	8	mA	$V_R = 5V, T_J = +125$ °C
		-	2.1	10	mA	$V_R = 40V, T_J = +125$ °C

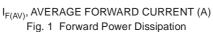
Notes:

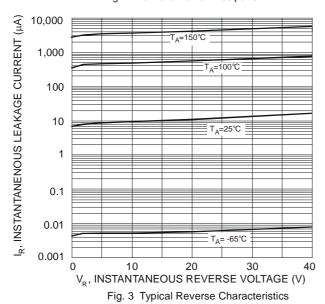
- 7. Theoretical R_{0JS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.
 8. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
 9. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
 10. Short duration pulse test used to minimize self-heating effect.



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10,000 I_E, INSTANTANEOUS FORWARD CURRENT (mA) T_A=100°C 1,000 T_A=150°C 100 10 0.1 $v_{\rm F}$, INSTANTANEOUS FORWARD VOLTAGE (V) 0 Fig. 2 Typical Forward Characteristics

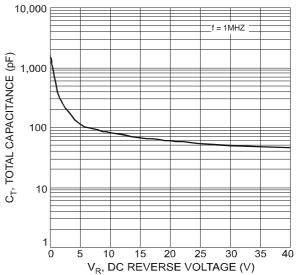
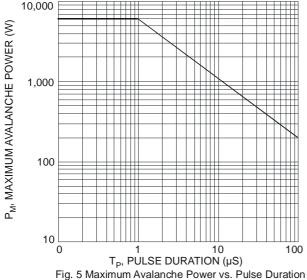
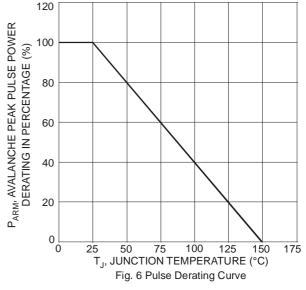


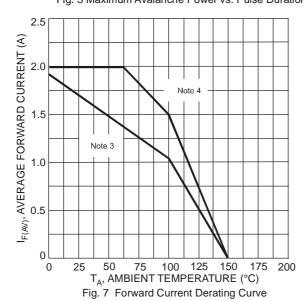
Fig. 4 Total Capacitance vs. Reverse Voltage

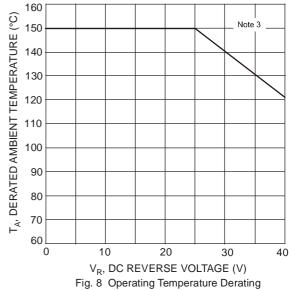


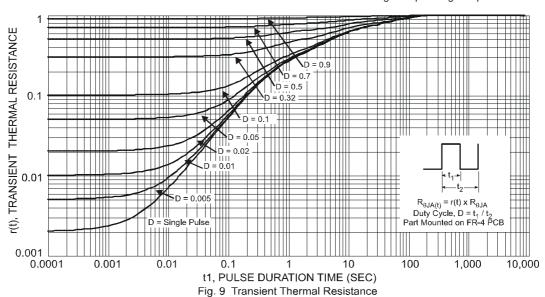
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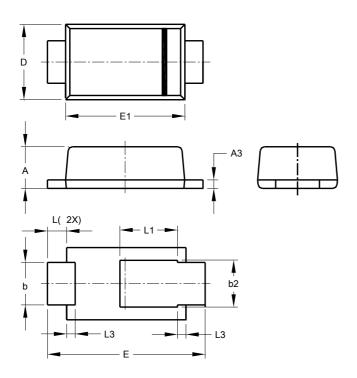






Package Outline Dimensions

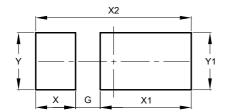
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



POWERDI®123					
Dim	Min	Max	Тур		
Α	0.93	1.00	0.98		
A3	0.15	0.25	0.20		
b	0.85	1.25	1.00		
b2	1.025	1.125	1.10		
D	1.63	1.93	1.78		
Е	3.50	3.90	3.70		
E1	2.60	3.00	2.80		
L	0.40	0.50	0.45		
L1	1.25	1.40	1.35		
L3	0.125	0.275	0.20		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)	
G	0.65	
X	1.05	
X1	2.40	
X2	4.10	
Y	1.50	
Y1	1.50	



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